

Analog Sound Processors series

Sound Processor for car audio built-in High-Voltage function and 2nd order post filter

BD37068FV-M

General Description

It is built-in input selector of 6 stereo source and output to ADC after adjusting signal level. And built-in $2^{\rm nd}$ order post filter to reduce out of band noise and 6ch Volume circuit. It is possible to out until 5.2 $V_{\rm RMS}$ at maximum output. (High Voltage function) Moreover, it is simple to design set by built-in TDMA noise reduction systems.

Features

- AEC-Q100 (Grade3) Qualified
- Built-in differential input selector that can select single-ended / differential input
- Reduce the pop noise when switching gain due to built-in advanced switch circuit
- Less out-of-band noise of DAC by built-in 2nd order post filter.
- Built-in buffered ground isolation amplifier to realize high CMRR characteristics
- Built-in TDMA noise reduction circuit reduces the additional components for external filter.
- It is possible to output 5.2V_{RMS} by High-Voltage function
- Package is SSOP-B40. Putting same direction input-terminals and output-terminals make PCB layout easier and PCB area smaller.
- Available to control by 3.3V/5V for I²C-bus controller

Applications

It is the optimal for the car audio. Besides, it is possible to use for the audio equipment of mini Compo, micro Compo.

Typical Application Circuit

Key Specifications(Note1)

■ Total Harmonic Distortion : 0.003%(Typ) Maximum Input Voltage: $2.2V_{RMS}(Typ)$ Common Mode Rejection Ratio: 55dB(Min) Maximum Output Voltage: $5.2V_{RMS}(Typ)$ Output Noise Voltage: $23\mu V_{RMS}(Typ)$ Residual Output Noise Voltage: $10.5\mu V_{RMS}(Typ)$ Ripple Rejection: -70dB (Typ) Operating Temperature Range: -40°C to +85°C

(Note1) These specifications are condition of High-Voltage ON.

Package SSOP-B40 W(Typ) x D(Typ) x H(Max) 13.60mm x 7.80mm x 2.00mm



SSOP-B40

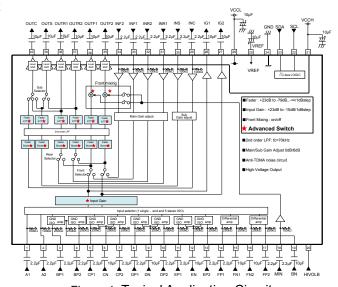


Figure 1. Typical Application Circuit

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Pin Configuration

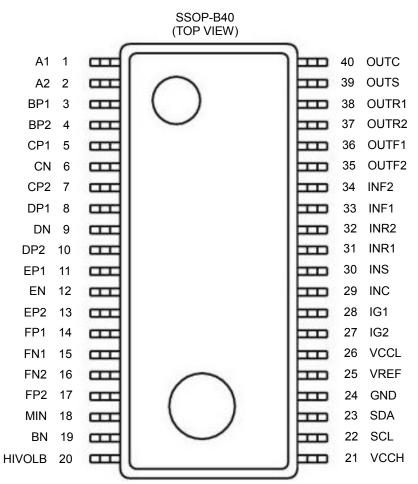


Figure 2. Pin configuration

Pin Descriptions

| in Descriptions | | | | | | | | | | |
|-----------------|----------|----------------------------------|---------|----------|---|--|--|--|--|--|
| Pin No. | Pin Name | Description | Pin No. | Pin Name | Description | | | | | |
| 1 | A1 | A input terminal of 1ch | 21 | VCCH | VCCH terminal for power supply | | | | | |
| 2 | A2 | A input terminal of 2ch | 22 | SCL | I ² C Communication clock terminal | | | | | |
| 3 | BP1 | B positive input terminal of 1ch | 23 | SDA | I ² C Communication data terminal | | | | | |
| 4 | BP2 | B positive input terminal of 2ch | 24 | GND | GND terminal | | | | | |
| 5 | CP1 | C positive input terminal of 1ch | 25 | VREF | BIAS terminal | | | | | |
| 6 | CN | C negative input terminal | 26 | VCCL | VCCL terminal for power supply | | | | | |
| 7 | CP2 | C positive input terminal of 2ch | 27 | IG2 | Input Gain output terminal of 2ch | | | | | |
| 8 | DP1 | D positive input terminal of 1ch | 28 | IG1 | Input Gain output terminal of 1ch | | | | | |
| 9 | DN | D negative input terminal | 29 | INC | Center input terminal | | | | | |
| 10 | DP2 | D positive input terminal of 2ch | 30 | INS | Subwoofer input terminal | | | | | |
| 11 | EP1 | E positive input terminal of 1ch | 31 | INR1 | Rear input terminal of 1ch | | | | | |
| 12 | EN | E negative input terminal | 32 | INR2 | Rear input terminal of 2ch | | | | | |
| 13 | EP2 | E positive input terminal of 2ch | 33 | INF1 | Front input terminal of 1ch | | | | | |
| 14 | FP1 | F positive input terminal of 1ch | 34 | INF2 | Front input terminal of 2ch | | | | | |
| 15 | FN1 | F negative input terminal of 1ch | 35 | OUTF2 | Front output terminal of 2ch | | | | | |
| 16 | FN2 | F negative input terminal of 2ch | 36 | OUTF1 | Front output terminal of 1ch | | | | | |
| 17 | FP2 | F positive input terminal of 2ch | 37 | OUTR2 | Rear output terminal of 2ch | | | | | |
| 18 | MIN | Mixing input terminal | 38 | OUTR1 | Rear output terminal of 1ch | | | | | |
| 19 | BN | B negative input terminal | 39 | OUTS | Subwoofer output terminal | | | | | |
| 20 | HIVOLB | Output Gain control terminal | 40 | OUTC | Center output terminal | | | | | |

Block Diagram

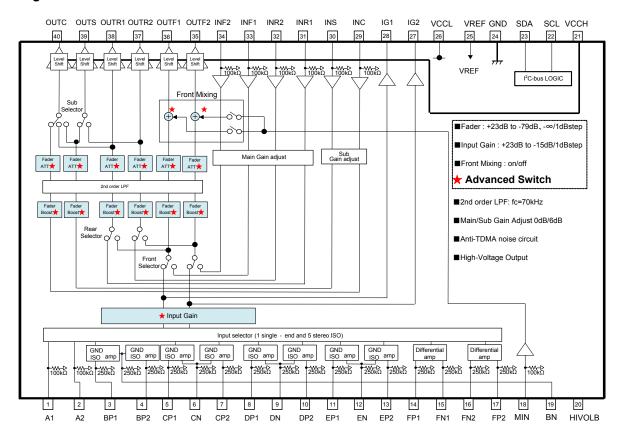


Figure 3. Block diagram and pin assign

Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Rating | Unit |
|----------------------|------------------|---|------|
| Dower Supply Voltage | VCCL | 10 | V |
| Power Supply Voltage | VCCH | 18 | ٧ |
| Input Voltage | V _{IN} | VCCL+0.3 to GND-0.3 Only SCL, SDA 7 to GND-0.3 | V |
| Power Dissipation | Pd | 1.12 ^(Note1) | W |
| Storage Temperature | T _{STG} | -55 to +150 | °C |

(Note1) This value decreases 9mW/ $^{\circ}$ C for Ta=25 $^{\circ}$ C or more.

ROHM standard board shall be mounted. Thermal resistance $\theta ja = 111.1(^{\circ}C /W)$.

ROHM Standard board size : $70x70x1.6(mm^2)$

material : A FR4 grass epoxy board(3% or less of copper foil area)

Operating Range

| Parameter | Symbol | Min | Тур | Max | Unit |
|------------------------|--------|------|-----|------|------|
| Davis a Comark Nothern | VCCL | 7.0 | 8.5 | 9.5 | V |
| Power Supply Voltage | VCCH | VCCL | 17 | 17.8 | V |
| Temperature | Topr | -40 | - | +85 | °C |

Electrical Characteristic

(Unless specified particularly, Ta=25 $^{\circ}$ C, VCCL=8.5V, VCCH=17.0V, f=1kHz, V_{IN}=1V_{RMS}, R_G=600 Ω , R_L=10k Ω , A input, Input Gain 0dB, Gain Adjust +6dB, High-Voltage ON, LPF ON, Fader 0dB, Input point=A1/A2, Monitor point=IG1/IG2)

| | | | | Limit | | | |
|----------------|---|---------------------|------|-------|------|-------------------|--|
| Block | Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
| General | Current upon no signal (VCCL) | I _{Q_VCCL} | _ | 30 | 43 | mA | No signal |
| Gel | Current upon no signal (VCCH) | I _{Q_VCCH} | - | 7 | 10 | mA | No signal |
| | Input Impedance (A) | R _{IN_S} | 70 | 100 | 130 | kΩ | |
| | Input Impedance (B, C, D, E, F) | R _{IN_D} | 175 | 250 | 325 | kΩ | |
| | Voltage Gain | G _V | -1.5 | +0 | +1.5 | dB | G _V =20log(V _{OUT} /V _{IN}) |
| | Channel Balance | СВ | -1.5 | +0 | +1.5 | dB | $CB = G_{V1}-G_{V2}$ |
| or | Total Harmonic Distortion | THD+N | _ | 0.003 | 0.05 | % | V _{OUT} =1V _{RMS} BW=400-30kHz |
| elect | Output Noise Voltage ^(Note1) | V _{NO1} | _ | 3.1 | 8.0 | μV _{RMS} | $R_G = 0\Omega$ BW = IHF-A |
| Input Selector | Maximum Input Voltage | V _{IM} | 2.0 | 2.2 | - | V _{RMS} | V _{IM} at THD+N(V _{OUT})=1% BW=400-30kHz |
| ll | Crosstalk Between Channels ^(Note1) | СТС | _ | -100 | -90 | dB | $R_G = 0\Omega$ CTC=20log(V_{OUT}/V_{OUT} ') BW = IHF-A |
| | Crosstalk Between Selectors ^(Note1) | CTS | _ | -100 | -90 | dB | $R_G = 0\Omega$ CTS=20log(V_{OUT}/V_{OUT} ') BW = IHF-A |
| | Common Mode Rejection Ratio (B, C, D, E, F) (Note1) | CMRR | 55 | 65 | _ | dB | XP1 and XN input XP2 and XN input CMRR=20log(V _{IN} /V _{OUT}) BW = IHF-A, [X=B,C,D,E,F] |
| | Minimum Input Gain | G _{IN MIN} | -17 | -15 | -13 | dB | Input gain -15dB G _{IN} =20log(V _{OUT} /V _{IN}) |
| nput Gain | Maximum Input Gain | G _{IN MAX} | 21 | 23 | 25 | dB | Input gain 23dB V _{IN} =100mV _{RMS} G _{IN} =20log(V _{OUT} /V _{IN}) |
| nbut | Gain Set Error | G _{IN ERR} | -2 | +0 | +2 | dB | GAIN=-15 to +23dB |
| = | Output Impedance | Rout | - | _ | 50 | Ω | V _{IN} =100mV _{RMS} |
| | Maximum Output Voltage | V _{OM} | 2.0 | 2.2 | _ | V _{RMS} | THD+N=1% BW=400-30kHz |

(Note1) VP-9690A (Average value detection, effective value display) filter by Panasonic is used for measurement. Input and output are in-phase.

(Unless specified particularly, Ta=25°C, VCCL=8.5V, VCCH=17.0V, f=1kHz, V_{IN} =0.9 V_{RMS} , R_{G} =600 Ω , R_{L} =10k Ω , A input, Input Gain 0dB, Gain Adjust +6dB, High-Voltage ON, LPF ON, Fader 0dB, Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS)

| ~ | | | | Limit | | | |
|--------|------------------------|-------------------|-----|-------|------|------------------|--|
| Block | Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
| | Output Impedance | R _{OUT} | - | _ | 50 | Ω | V _{IN} =100mV _{RMS} |
| Output | Maximum Output Voltage | V _{OM} | 5.1 | 5.2 | _ | V _{RMS} | V _{IN} =1V _{RMS} THD+N=1% BW=400-30kHz |
| 0 | Maximum Output Gain | G _{Hout} | 6.3 | 8.3 | 10.3 | dB | G _{Hout} =20log(V _{OUT} /V _{IN}) |

(Unless specified particularly, Ta=25°C, VCCL=8.5V, VCCH=17.0V, f=1kHz, V_{IN} =0.9 V_{RMS} , R_{G} =600 Ω , R_{L} =10k Ω , A input, Input Gain 0dB, Gain Adjust +6dB, High-Voltage ON, LPF ON, Fader 0dB, Input point=INF1/INF2/INR1/INR2/INC/INS, Monitor point=OUTF1/OUTF2/OUTR1/OUTR2/OUTC/OUTS)

| | | | | Limit | | | |
|-------------|--|----------------------|------|-------|------|-------------------|---|
| Block | Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
| | Maximum Boost Gain | G _{F BST} | 21 | 23 | 25 | dB | Gain=23dB V _{IN} =100mV _{RMS} G _F =20log(V _{OUT} /V _{IN})-G _{Hout} Gain Adjust=0dB |
| | Channel Balance | СВ | -1.5 | +0 | +1.5 | dB | $CB = G_{V1}-G_{V2}$ |
| | Total Harmonic Distortion | THD+N | _ | 0.003 | 0.05 | % | BW=400-30kHz |
| | Output Noise Voltage ^(Note1) | V_{NO1} | _ | 23 | 40 | μV_{RMS} | $R_G = 0\Omega$ BW = IHF-A |
| | Residual Output Noise Voltage ^(Note1) | V _{NOR} | _ | 10.5 | 20 | μV _{RMS} | Fader = $-\infty$ dB $R_G = 0\Omega$ BW = IHF-A |
| | Maximum Input Voltage | V _{IM} | 2.0 | 2.1 | _ | V _{RMS} | V _{IM} at THD+N(V _{OUT})=1% BW=400-30kHz Gain Adjust = 0dB |
| Fader | Crosstalk Between Channels ^(Note1) | стс | _ | -100 | -90 | dB | $R_G = 0\Omega$ CTC=20log(V _{OUT} /V _{OUT} ') BW = IHF-A |
| | Maximum Attenuation ^(Note1) | G _{F MIN} | _ | -100 | -90 | dB | Fader = -∞dB G _F =20log(V _{OUT} /V _{IN}) BW = IHF-A |
| | Gain Set Error | G _{F ERR} | -2 | +0 | +2 | dB | Gain=+1 to +23dB |
| | Attenuation Set Error 1 | G _{F ERR1} | -2 | +0 | +2 | dB | Attenuation=0 to -15dB |
| | Attenuation Set Error 2 | G _{F ERR2} | -3 | +0 | +3 | dB | Attenuation=-16 to -47dB |
| | Attenuation Set Error 3 | G _{F ERR3} | -4 | +0 | +4 | dB | Attenuation=-48 to -79dB |
| | Ripple Rejection | PSRR _{VCCL} | _ | -70 | -40 | dB | f=1kHz V _{PSRL} =100mV _{RMS} PSRR _{VCCL} =20log(V _{OUT} /VCCL) |
| | Trippie rejection | PSRR _{VCCH} | _ | -70 | -40 | dB | f=1kHz V _{PSRH} =100mV _{RMS} PSRR _{VCCH} =20log(V _{OUT} /VCCH) |
| | Input Impedance | R _{IN_M} | 70 | 100 | 130 | kΩ | |
| | Maximum Input voltage | V _{IM_M} | 2.0 | 2.2 | - | V _{RMS} | V _{IM} at THD+N(V _{OUT})=1% BW=400-30kHz MIN input |
| Mixing | Maximum Attenuation ^(Note1) | G _{MX} MIN | - | -100 | -85 | dB | Front Mixing OFF G _{MX} =20log(V _{OUT} /V _{IN}) BW=IHF-A MIN input |
| | Mixing Gain | G _{MX} | -2 | +0 | +2 | dB | Front Mixing ON G _{MX} =20log(V _{OUT} /V _{IN})-G _{Hout} |
| | Input Impedance | R _{IN_M} | 70 | 100 | 130 | kΩ | |
| Gain Adjust | Boost Gain | G _{F BST} | 4 | 6 | 8 | dB | $\begin{aligned} & \text{Gain=6dB} \\ & \text{V}_{\text{IN}} = 100 \text{mV}_{\text{RMS}} \\ & \text{G}_{\text{F}} = 20 \text{log}(\text{V}_{\text{OUT}}/\text{V}_{\text{IN}}) \text{-} \text{G}_{\text{Hout}} \end{aligned}$ |
| Ö | Channel Balance | СВ | -1.5 | +0 | +1.5 | dB | $CB = G_{V1}-G_{V2}$ |

(Note1) VP-9690A (Average value detection, effective value display) filter by Panasonic is used for measurement. Input and output are in-phase.

Typical Performance Curve(s)

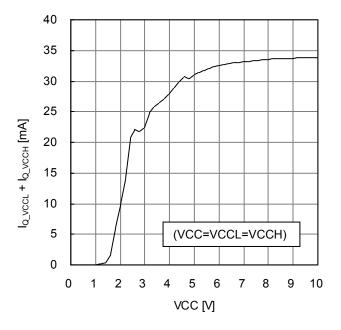


Figure 4. $I_{Q_VCCL} + I_{Q_VCCH}$ vs VCC

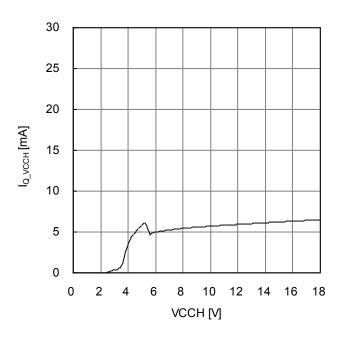


Figure 5. I_{Q_VCCH} vs VCCH (High-Voltage ON)

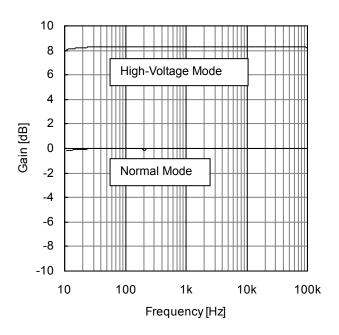


Figure 6. Gain vs Frequency (Normal / High-Voltage mode)

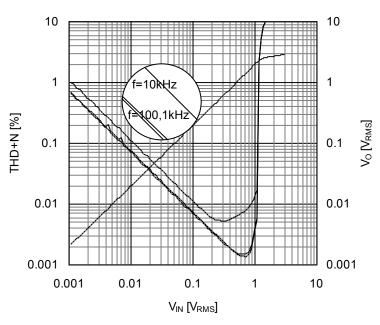
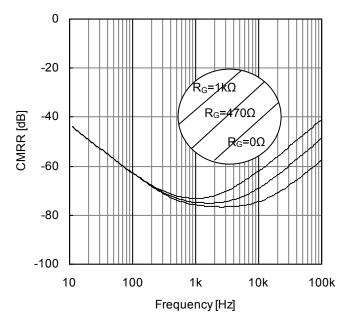


Figure 7. THD+N, V_O vs V_{IN} (Gain Adjust=+6dB)





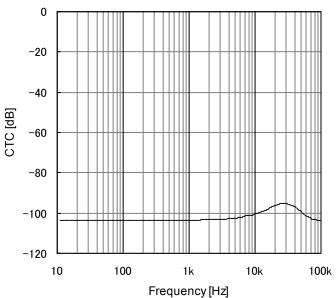


Figure 9. CTC vs Frequency

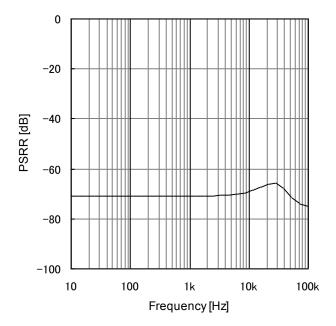


Figure 10. PSRR vs Frequency

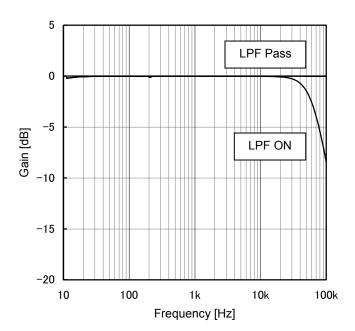


Figure 11. Gain vs Frequency (LPF ON/Pass)

I²C-bus Control Signal Specification

1. Electrical specifications and timing for bus lines and I/O stages

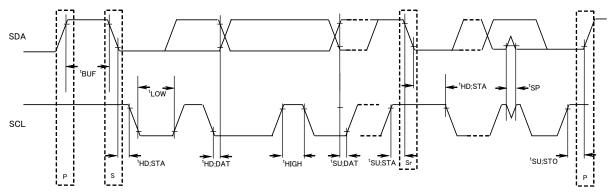


Figure 12. Definition of timing on the I²C-bus

Table 1 Characteristics of the SDA and SCL bus lines for I²C-bus devices

| | Parameter | Symbol | Fast-mode l | C-bus | Unit |
|---|---|---------|-------------|-------|-------|
| | Falanielei | Symbol | Min | Max | Offic |
| 1 | SCL Clock Frequency | fSCL | 0 | 400 | kHz |
| 2 | Bus Free time between a STOP and START condition | tBUF | 1.3 | _ | µsec |
| 3 | Hold Time (repeated) START condition. After this period, the first clock pulse is generated | tHD;STA | 0.6 | _ | μsec |
| 4 | LOW Period of the SCL Clock | tLOW | 1.3 | _ | µsec |
| 5 | HIGH Period of the SCL Clock | tHIGH | 0.6 | _ | μsec |
| 6 | Set-up time for a Repeated START Condition | tSU;STA | 0.6 | _ | µsec |
| 7 | Data Hold Time | tHD;DAT | 0* | _ | µsec |
| 8 | Data set-up Time | tSU;DAT | 100 | _ | nsec |
| 9 | Set-up Time for STOP Condition | tSU;STO | 0.6 | _ | µsec |

All values referred to VIH min. and VIL max. Levels (see Table 2).

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

| | Parameter | Symbol | Fast-mode l ² | C-bus | Unit |
|----|--|----------------|--------------------------|-------|----------|
| | Faranteter | Symbol | Min | Max | Offic |
| 10 | LOW level input voltage: Fixed input levels | VIL | -0.5 | +1 | V |
| 11 | HIGH level input voltage: Fixed input levels | VIH | 2.3 | - | V |
| 12 | Pulse width of spikes, which must be suppressed by the input filter. | tSP | 0 | 50 | nsec |
| 13 | LOW level output voltage (open drain or open collector): At 3mA sink current | VOL1 | 0 | 0.4 | > |
| 14 | Input current each I/O pin with an input voltage between 0.4V and 0.9 VDD max. | l _i | -10 | +10 | μΑ |

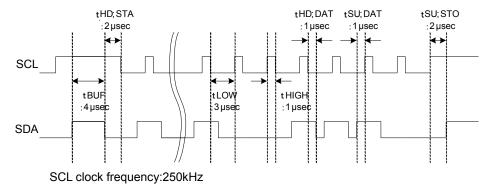


Figure 13. I²C data transmission timing

I²C-bus Format

| | MSB LSB | | MSB | LSB | | MSB | LSB | | | |
|------|----------------|---------------------------------------|--|---------------|--------|--------------------|-----------|-------|------|--|
| S | Slave Address | Α | Select A | Address | Α | Data | | Α | Р | |
| 1bit | 8bit | 1bit 8bit | | 8bit | 1bit | 8bit | 1 | 1bit | 1bit | |
| | S | = Sta | art condition | (Recognition | n of | start bit) | | | | |
| | Slave Address | = Re | cognition of | f slave addre | ess. 7 | bits in upper orde | er are op | tiona | al. | |
| | | The last bit must be "L" for writing. | | | | | | | | |
| | Α | = Ac | knowledge | bit (Recogni | tion c | of acknowledgeme | ent) | | | |
| | Select Address | = Ad | dress for ea | ch function | | | | | | |
| | Data | = Data of each function | | | | | | | | |
| | Р | = Sto | = Stop condition (Recognition of stop bit) | | | | | | | |

I²C-bus Interface Protocol

1) Basic form

| S | Slave Addre | ess A | S | elect Address | Α | Data | Α | Р |
|---|-------------|-------|-----|---------------|---|--------|---|---|
| | MSB | LSB | MSB | LSB | М | SB LSI | В | |

2) Automatic increment(Select Address increases (+1) according to the number of data)

| S | Slave Address | Α | Select Address | À | Data ² | 1 | Α | Data2 | Α | | Data N | Α | Р |
|---|---------------|---|----------------|---|-------------------|-----|---|-------|----|---|--------|----|---|
| | MSB LSB | | MSB LSE | 3 | MSB | LSB | | MSB L | SB | N | /ISB L | SB | |

(Example) ① Data 1 shall be set as data of address specified by Select Address.

- ②Data 2 shall be set as data of address specified by Select Address +1.
- ③Data N shall be set as data of address specified by Select Address +(N-1).

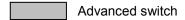
| 3) Configuration | ı unavailable for trai | nsmission (In th | is case, only | y Select Add | ress 1 is | set.) | | | | |
|------------------|--|------------------|---------------|--------------|------------|-------|-------|---|--|--|
| S Slave Add | ress A Select | Address1 A | Data A | Select Ad | dress 2 | A Da | ata A | Р | | |
| MSB | LSB MSB | LSB M | SB LSB | MSB | LSB | MSB | LSB | | | |
| | (Note)If any dat | a is transmitted | as Select A | ddress 2 nex | kt to data | , | | | | |
| | It is recognized as data, not as Select Address 2. | | | | | | | | | |

Slave Address

| MSB | | | | | | | LSB | |
|-----|----|----|----|----|----|----|-----|---------|
| A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W | |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 80(hex) |

5. Select Address & Data

| Items | Select Address | MSB | | | Da | ata | | | LSB |
|---------------------|-------------------|---------------------------|--------|----------------------|--|-------------|---------|-------------------|------------------------|
| items | (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Initial Setup 1 | 01 | Advanced switch ON/OFF | 0 | time o | Advanced switch time of Input 0 0 0 Gain/Fader | | | 0 | 0 |
| Initial Setup 2 | 02 | 0 | 0 | Sub S | Sub Selector 0 0 Rear Selector | | | Front Selector | |
| Input Selector | 05 | 0 | 0 | 0 | 0 | | Input S | Selector | |
| Input Gain | 06 | 0 | 0 | | | Input | Gain | | |
| Fader 1ch Front | 28 | | | Fa | der Gain / | Attenuatio | า | | |
| Fader 2ch Front | 29 | | | Fa | der Gain / | Attenuatio | า | | |
| Fader 1ch Rear | 2A | | | Fa | der Gain / | Attenuation | า | | |
| Fader 2ch Rear | 2B | | | Fa | der Gain / | Attenuation | า | | |
| Fader Center | 2C | | | Fa | der Gain / | Attenuation | า | | |
| Fader Subwoofer | 2D | | | Fa | der Gain / | Attenuation | า | | |
| LPF setup Mixing | 30 | Front Mixing ON/OFF | LPF fc | PF fc 0 0 0 0 Gain 0 | | | | | Main Gain Adjust |
| System Reset | FE | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |



Note) Set up bit (It is written with "0" by the above table) which hasn't been used in "0".

Notes on data format

- 1. "Advanced switch" function is available for the hatched parts on the above table.
- 2. In case of transferring data continuously, Select Address (hex) flows by Automatic increment function, as shown below.

$$\rightarrow$$
01 \rightarrow 02 \rightarrow 05 \rightarrow 06 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C \rightarrow 2D \rightarrow 30

- 3. Input selector that is not corresponded for "Advanced switch" function, cannot reduce the noise caused when changing the input selector. Therefore, it is recommended to turn on mute when changing these settings.
- 4. In case of setting to infinite "-∞" by using Fader when input selector setting is changed, please consider "Advanced switch" time.

Select Address 01 (hex)

| Mode | MSB | | Advanced switch time of Input Gain/Fader D5 | | | | | | |
|-----------|-----------------|--------|--|----|----|----|----|----|--|
| | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 4.7 msec | Advanced | | 0 | 0 | | | | | |
| 7.1 msec | Advanced switch | 0 | 0 | 1 | _ | 0 | 0 | 0 | |
| 11.2 msec | ON/OFF | U | 1 | 0 | U | U | U | U | |
| 14.4 msec | ON/OFF | ON/OFF | | 1 | 1 | | | | |

| Mode | MSB | | Advanced switch ON/OFF | | | | | | |
|-------|-----|----|------------------------|-------------------------------|----|----|----|----|--|
| Wiode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| OFF | 0 | 0 | | Advanced switch time of Input | | 0 | 0 | 0 | |
| ON | 1 | | | /Fader | U | U | U | U | |

Select Address 02 (hex)

| Mode | MSB | | | Front | Selector | | | LSB |
|---------------|------|----|-------|---------|----------|----|----------|-----|
| IVIOGE | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| FRONT | 0 | 0 | Cub C | olootor | 0 | 0 | Rear | 0 |
| INSIDE THROUG | iH U | U | Sub S | elector | U | U | Selector | 1 |

| Mode | MSB | Rear Selector | | | | | | | |
|------------|-----|---------------|--------|---------|----|----|----|----------|--|
| IVIOGC | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| REAR | 0 | 0 | Cult C | alaatan | 0 | 0 | 0 | Front | |
| FRONT COPY | U | U | Sub S | elector | U | U | 1 | Selector | |

| Mode ^(Note1) | MSB | Sub Selector | | | | | | |
|--------------------------|-----|--------------|----|----|----|----|----------|----------|
| lviode. | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| OUTC(INS) OUTS(INS) | | | 0 | 0 | | | | |
| OUTC(INR1) OUTS(INR2) | 0 | 0 | 0 | 1 | 0 | 0 | Rear | Front |
| OUTC (INC) OUTS(INS) | 0 | U | 1 | 0 | O | | Selector | Selector |
| Prohibition | | | 1 | 1 | | | | |

 $(Note1)\; xxx(INxx): \text{``} xxx\text{''}\; means \; \text{``} Output \; terminal'', \; \text{``} (INxx)\text{''}\; means \; \text{``} Output \; signal''$

Select Address 05(hex)

| Mode | MSB | | | Input S | elector | | | LSB |
|-------------|-----|----|----|---------|---------|----|----|-----|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Α | | | | | 0 | 0 | 0 | 0 |
| B single | | | | | 0 | 0 | 0 | 1 |
| C single | | | | | 0 | 0 | 1 | 0 |
| D single | | | | | 0 | 0 | 1 | 1 |
| E single | | | | | 0 | 1 | 0 | 0 |
| F single | | | | | 0 | 1 | 0 | 1 |
| C diff | | | | | 0 | 1 | 1 | 0 |
| D diff | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 |
| E diff | | | | | 1 | 0 | 0 | 0 |
| F full-diff | | | | | 1 | 0 | 0 | 1 |
| B diff | | | | | 1 | 0 | 1 | 0 |
| | | | | | 1 | 0 | 1 | 1 |
| Prohibition | | | | | : | : | : | : |
| | | | | | 1 | 1 | 1 | 1 |

: Initial condition

List of active input terminal when set input selector

| Mode | Lch positive input terminal | Lch negative input terminal | Rch positive input terminal | Rch negative input terminal |
|-------------|-----------------------------|--------------------------------|-----------------------------|--------------------------------|
| Α | 1pin(A1) | - | 2pin(A2) | - |
| B single | 3pin(BP1) | - | 4pin(BP2) | - |
| C single | 5pin(CP1) | - | 7pin(CP2) | - |
| D single | 8pin(DP1) | - | 10pin(DP2) | - |
| E single | 11pin(EP1) | - | 13pin(EP2) | - |
| F single | 14pin(FP1) | - | 17pin(FP2) | - |
| B diff | 3pin(BP1) | 19pin(BN) | 4pin(BP2) | 19pin(BN) |
| C diff | 5pin(CP1) | 6pin(CN) | 7pin(CP2) | 6pin(CN) |
| D diff | 8pin(DP1) | 9pin(DN) | 10pin(DP2) | 9pin(DN) |
| E diff | 11pin(EP1) | 12pin(EN) | 13pin(EP2) | 12pin(EN) |
| F full-diff | 14pin(FP1) | 15pin(FN1) | 17pin(FP2) | 16pin(FN2) |

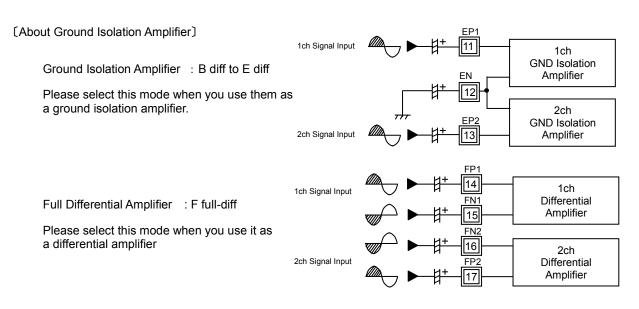


Figure 14. About Ground Isolation Amplifier

Select Address 06 (hex)

| Mode | MSB | | | | Gain | | | LSE |
|---------------|-----|----|----|----|------|----|----------|-----|
| IVIOGC | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | | | 0 | 0 | 0 | 0 | 0 | 0 |
| Prohibition | | | : | : | : | : | : | : |
| | | | 0 | 0 | 1 | 0 | 0 | 0 |
| +23dB | | | 0 | 0 | 1 | 0 | 0 | 1 |
| +22dB | | | 0 | 0 | 1 | 0 | 1 | 0 |
| +21dB | | | 0 | 0 | 1 | 0 | 1 | 1 |
| +20dB | | | 0 | 0 | 1 | 1 | 0 | 0 |
| +19dB | | | 0 | 0 | 1 | 1 | 0 | 1 |
| +18dB | | | 0 | 0 | 1 | 1 | 1 | 0 |
| +17dB | | | 0 | 0 | 1 | 1 | 1 | 1 |
| +16dB | | | 0 | 1 | 0 | 0 | 0 | 0 |
| +15dB | | | 0 | 1 | 0 | 0 | 0 | 1 |
| +14dB | | | 0 | 1 | 0 | 0 | 1 | 0 |
| +13dB | | | 0 | 1 | 0 | 0 | 1 | 1 |
| +12dB | | | 0 | 1 | 0 | 1 | 0 | 0 |
| +11dB | | | 0 | 1 | 0 | 1 | 0 | 1 |
| +10dB | | | 0 | 1 | 0 | 1 | 1 | 0 |
| +9dB | | | 0 | 1 | 0 | 1 | 1 | 1 |
| +8dB | | | 0 | 1 | 1 | 0 | 0 | 0 |
| +7dB | | | | 1 | 1 | 0 | 0 | 1 |
| +6dB | | | 0 | 1 | 1 | 0 | 1 | 0 |
| +5dB | | | 0 | 1 | 1 | 0 | 1 | 1 |
| +4dB | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 |
| +3dB | U | U | 0 | 1 | 1 | 1 | 0 | 1 |
| +2dB | | | 0 | 1 | 1 | 1 | 1 | 0 |
| +1dB | | | 0 | 1 | 1 | 1 | 1 | 1 |
| 0dB | | | 1 | 0 | 0 | 0 | 0 | 0 |
| -1dB | | | 1 | 0 | 0 | 0 | 0 | 1 |
| -2dB | | | 1 | 0 | 0 | 0 | 1 | 0 |
| -3dB | 1 | | 1 | 0 | 0 | 0 | 1 | 1 |
| -4dB | 1 | | 1 | 0 | 0 | 1 | 0 | 0 |
| -5dB | 1 | | 1 | 0 | 0 | 1 | 0 | 1 |
| -6dB | 1 | | 1 | 0 | 0 | 1 | 1 | 0 |
| -7dB | 1 | | 1 | 0 | 0 | 1 | 1 | 1 |
| -8dB | - | | 1 | 0 | 1 | 0 | 0 | 0 |
| -9dB | - | | 1 | 0 | 1 | 0 | 0 | 1 |
| -90B -10dB | + | | 1 | 0 | 1 | 0 | 1 | 0 |
| | - | | 1 | 0 | 1 | 0 | 1 | |
| -11dB | - | | | | | | + | 1 |
| -12dB | | | 1 | 0 | 1 | 1 | 0 | 0 |
| -13dB | | | 1 | 0 | 1 | 1 | 0 | 1 |
| -14dB | | | 1 | 0 | 1 | 1 | 1 | 0 |
| -15dB | | | 1 | 0 | 1 | 1 | 1 | 1 |
| | | | 1 | 1 | 0 | 0 | 0 | 0 |
| Prohibition | | | : | : | : | : | : | : |
| | | | 1 | 1 | 1 | 1 | 1 | 1 |

Select Address 28, 29, 2A, 2B, 2C, 2D (hex)

| Gain & ATT | MSB | (- / | | Fader Gain | / Attenuatior | 1 | | LSB |
|---------------|-----|-------|----|------------|---------------|----|----|-----|
| Gaill & All I | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Prohibition | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Proffibilion | : | : | : | : | : | : | : | : |
| | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0 |
| +23dB | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 |
| +22dB | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 |
| +21dB | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 |
| • | • | | • | | | • | | • |
| | | | | • | • | • | • | |
| +10dB | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| +9dB | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 |
| +8dB | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| +7dB | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 |
| +6dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 |
| +5dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 |
| +4dB | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 |
| +3dB | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 |
| +2dB | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| +1dB | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| 0dB | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| -1dB | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| -2dB | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| -3dB | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| :: | :: | :: | :: | | : : | | | |
| -78dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -79dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 |
| Prohibition | : | : | : | : | : | : | : | : |
| | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| -∞dB | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Select Address 30(hex)

| Mode | MSB | MSB Main Gain Adjust | | | | | | | | |
|------|-----------------|----------------------|----|----|----|----|--------------------|----|--|--|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| 0dB | Front Mixing | LPF fc | 0 | 0 | 0 | 0 | Sub Gain Adjust | 0 | | |
| +6dB | | | | | | U | | 1 | | |
| | | | | | | | | | | |
| | | | | | | | | | | |

| Mode | MSB | | | LSB | | | | |
|------|-----------------|--------|----|-----|----|----|----|------------------------|
| | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0dB | Front Mixing | LPF fc | 0 | 0 | 0 | 0 | 0 | Main Gain Adjust |
| +6dB | | | | | | | 1 | |

| Mada | MSB | | | LSB | | | | |
|-------|-----------------|----|----|-----|----|----|--------------------|----------------|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 70kHz | Front Mixing | 0 | _ | _ | _ | 0 | Sub Gain Adjust | Main |
| PASS | | 1 | 0 | 0 | 0 | | | Gain Adjust |

| Mode | MSB | | | Front Mixing ON/OFF | | | | | |
|------|-----|---------|----|---------------------|----|----|----------|----------------|--|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| OFF | 0 | 1 DE 4- | 0 | 0 | _ | | Sub Gain | Main | |
| ON | 1 | LPF fc | Ü | U | U | U | Adjust | Gain Adjust | |

6. About power on reset

It is possible for the reset circuit inside the IC to initialize when supply voltage is turned on. Please send data to all address as initial data when the supply is turned on, and turn on mute until all initial data are sent.

| Itom | Cumbal | Limit | | | Unit | Condition |
|------------------|-------------------|-------|-----|-----|------|-----------------------------|
| Item | Symbol | Min | Тур | Max | Unit | Condition |
| Rise time of VCC | t _{RISE} | 33 | - | _ | µsec | VCC rise time from 0V to 5V |
| VCC voltage of | | | | | | |
| release power on | V_{POR} | _ | 4.1 | _ | V | |
| reset | | | | | | |

7. About start-up and power off sequence on IC

By setting the terminal voltage of HIVOLB, it is possible to change the output gain. At the same time, output DC voltage will also be changed at each mode.

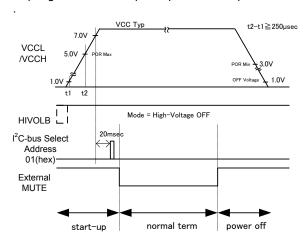
| HIVOLB terminal voltage | High-Voltage |
|-------------------------|--------------|
| GND to 1.0V | ON |
| 2.3V to VCCL | OFF |

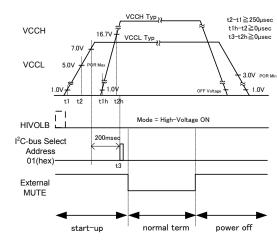
Please set HIVOLB terminal voltage between the ranges showed by the above tables. If HIVOLB terminal is open, the terminal voltage will be set to 5V due to the pull-up voltage inside the IC. In this case, the IC will be set to "High-Voltage OFF" mode.

The relationship between DC Bias and Output Gain to the configuration of HIVOLB terminal shows as the following table.

| VCCH Supplied Voltage | 8.5 V | 17 V |
|-------------------------|----------------------------------|--------------------------|
| HIVOLB Terminal Voltage | Open (5 V) (High-Voltage OFF) | 0 V (High-Voltage ON) |
| Output DC Bias Voltage | 4.15 V | 8.35 V |
| Output Gain | 0 dB | 8.3 dB |

If HIVOLB terminal voltage is changed during its operation, Output DC voltage will be also changed shown as above. For reducing these variations, turn the power on after setting the status of the HIVOLB terminal according to the output gain. The start-up and power off sequence is shown next.





Normal mode operation (HIVOLB terminal = OPEN)

High-Voltage mode operation

Figure 15. Power off and start-up sequence in each mode

This IC will become active-state by sending data of Select Address 01(hex) on I²C-bus. Therefore, this command must always send in start-up sequence. In addition, External MUTE means recommended period that the muting outside IC. In addition, the starting sequence of VCCL and VCCH does not have the limit, but please start VCCL earlier to reduce a pop noise.

About HIVOLB terminal, but measures have been made spike removal, please note that the IC may accept when receiving input more than 50nsec.

Fader Volume Attenuation of the Detail

| (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------------|----|----|----|----|----|----|----|----|------------|----|----|----|----|----|----|----|----|
| +23 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | -29 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 |
| +22 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | -30 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 |
| +21 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | -31 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 |
| +20 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | -32 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| +19 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | -33 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 |
| +18 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | -34 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 |
| +17 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | -35 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 |
| +16 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | -36 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 |
| +15 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | -37 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 |
| +14 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | -38 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 |
| +13 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | -39 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 |
| +12 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | -40 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 |
| +11 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | -41 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 |
| +10 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | -42 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 |
| +9 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | -43 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 |
| +8 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | -44 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 |
| +7 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | -45 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 |
| +6 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | -46 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0 |
| +5 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | -47 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 |
| +4 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | -48 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| +3 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | -49 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 |
| +2 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | -50 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 |
| +1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | -51 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | -52 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 |
| -1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | -53 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 |
| -2 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | -54 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0 |
| -3 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | -55 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 |
| -4 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | -56 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 |
| -5 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | -57 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1 |
| -6 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | -58 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 |
| -7 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | -59 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 |
| -8 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | -60 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0 |
| -9 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | -61 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 |
| -10 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | -62 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| -11 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | -63 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| -12 -13 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | -64 -65 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| -13 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | -66 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 |
| -14 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | -67 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 |
| -16 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | -68 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 |
| -17 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | -69 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 |
| -18 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | -70 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 |
| -19 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | -70 -71 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 |
| -20 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | -72 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 |
| -21 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | -73 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 |
| -22 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | -74 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 |
| -23 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | -75 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| -24 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | -76 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 |
| -25 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | -77 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| -26 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | -78 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -27 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | -79 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| -28 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | -∞ | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| <u> </u> | | | | | | | | | | | | | | | | | |

About bias voltage of output terminal(27,28,35 to 40pin) vs. VCC

Bias voltage of output terminal (27,28,35 to 40pin) keep fixed voltage in operational range of VCC.

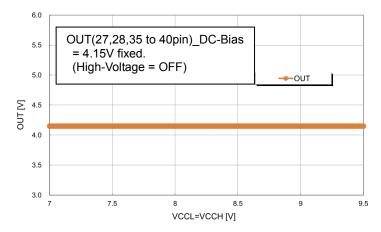


Figure 16. OUT(27,28,35 to 40pin)_DC-Bias = 4.15V fixed. (High-Voltage Mode = OFF)

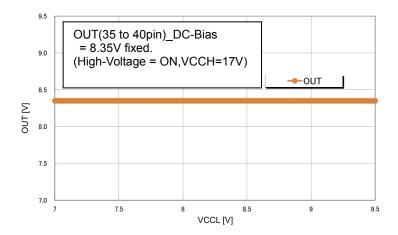


Figure 17. OUT(35 to 40pin)_DC-Bias = 8.35V fixed. (High-Voltage Mode = ON, VCCH=17V)

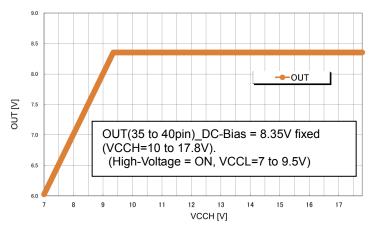


Figure 18. OUT(35 to 40pin)_DC-Bias = 8.35V fixed(VCCH=10 to 17.8V). (High-Voltage Mode = ON, VCCL=7 to 9.5V)

About Advanced Switch Circuit

[1] Advanced switch technology

1-1. Advanced switch effects

Advanced switch technology is ROHM original technology that can prevent from switching pop noise. If changing the gain setting (for example Fader) immediately, the audible signal will become discontinuously and pop noise will be occurred. This Advanced switch technology will prevent this discontinuous signal by completing the signal waveform and will significantly reduce the noise.

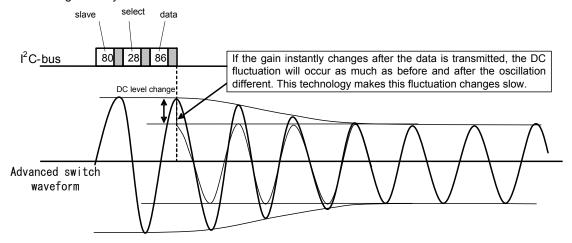


Figure 17. The explanation of advanced switch waveform

This Advanced switch circuit will start operating when the data is transmitted from microcontroller.

Advanced switch waveform is shown as the figure above. For preventing switching noise, this IC will operate optimally by internal processing after the data is transmitted from microcontroller.

However, sometimes the switching waveform is not like the intended form depends on the transmission timing. Therefore, below is the example of the relationship between the transmission timing and actual switching time. Please consider this relationship for the setting.

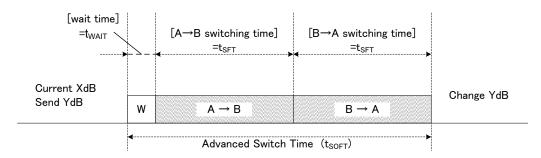
1-2. The kind of the Transferring Data

- Data setting that is not corresponded to Advanced switch (Page11 Select Address & Data Data format without hatching)
 There is no particular rule about transferring data.
- Data setting that is corresponded to Advanced switch
 (Page11 Select Address & Data Data format with hatching)
 There is no particular rule about transferring data, but Advanced switch must follow the switching sequence as mentioned in [2] as follows.

[2] Data transmission that is corresponded to Advanced switch

2-1. Switching time of Advanced switch

Switching time includes [t_{WAIT} (Wait time)], [t_{SFT} (A \rightarrow B switching time)] and [t_{SFT} (B \rightarrow A switching time)]. 25msec is needed per 1 switching. (t_{SOFT} = t_{WAIT} + 2 * t_{SFT} , t_{WAIT} =2.3msec, t_{SFT} =11.2msec)



In the figure above, Start/Stop state is expressed as "A" and temporary state is expressed as "B".

The switching sequence of Advanced switch consists of the cycle "A(start) \rightarrow B(temporary) \rightarrow A(stop)". Therefore, switching sequence will not stop at B state.

For example, switching is performed from A(Initial gain) \rightarrow B(set gain) \rightarrow A(set gain) when switching from initial gain to set gain. And switching time (t_{SFT}) of A \rightarrow B or B \rightarrow A are equal.

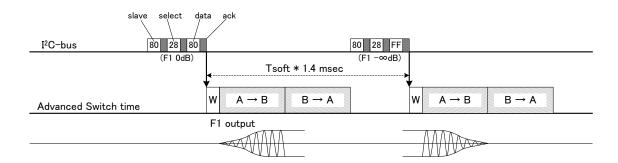
2-2. About the data transmission's timing in same block state and switching operation

■ Transmitting example 1

This is an example when transmitting data in same block with "enough interval for data transmission". (enough interval for data transmission : 1.4 x t_{SOFT} * "1.4" includes tolerance margin.)

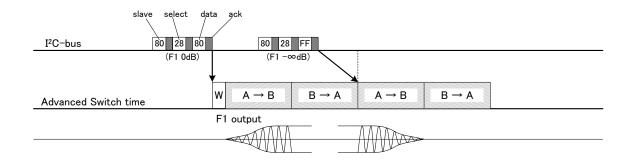
Definition of example expression:

F1=Fader 1ch Front, F2=Fader 2ch Front, R1=Fader 1ch Rear, R2=Fader 2ch Rear C=Fader Center, S=Fader Subwoofer, MIX=Front Mixing



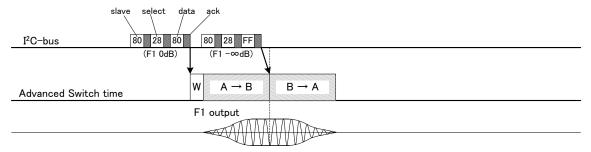
■ Transmitting example 2

This is an example when the transmission interval is not enough (smaller than "Transmission example 1"). When the data is transmitted during first switching operation, the second data will be reflected after the first switching operation. In this case, there is no wait time (t_{WAIT}) before the second switching operation.



■ Transmitting example 3

This is an example of switching operation when transmission interval is smaller than "Transmission example 2"). When the data is transmitted during the first switching operation, and transmission timing is just during $A \rightarrow B$ switching operation, the second data will be reflected at $B \rightarrow A$ switching term.

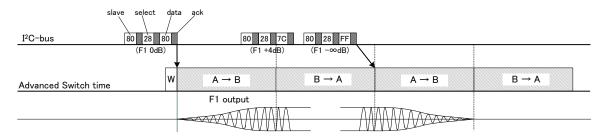


■ Transmitting example 4

The below figure shows an example of switching operation that the data are transmitted serially with smaller transmission interval than "Transmission example 3".

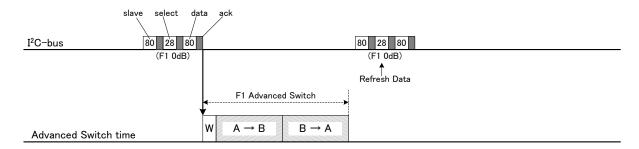
IC has internal data-storage buffer and buffer transmitted data as storage data constantly.

However, only the latest data is kept so, in this example, +4dB data transmitted secondly is ignored.



■ Transmitting example 5

Transmitted data is firstly buffered and written to setting data which set gain. However, when there is no difference between transmitted data and setting data such as refresh data, advanced switch operation doesn't start.

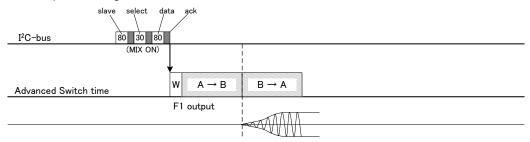


2-3. Mixing ON/OFF switching operation of Front mixing

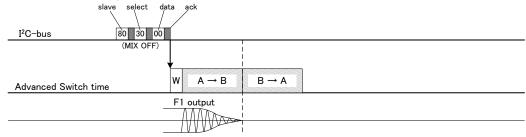
The action of the Mixing switching waveform is different in OFF to ON or ON to OFF.

■ Transmission example 1

This is an example of Mixing OFF to ON state.



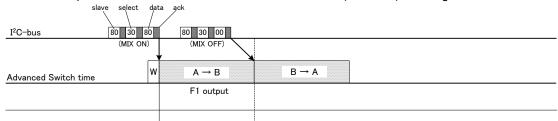
This is an example of Mixing ON to OFF state



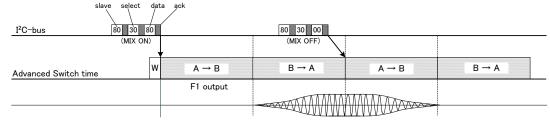
■ Transmission example 2

This is an example when transmission ON to OFF in short interval during to Mixing switching operation.

This is an example of in case of transmitted data of another status(MIX OFF) in during A→B transmission timing.

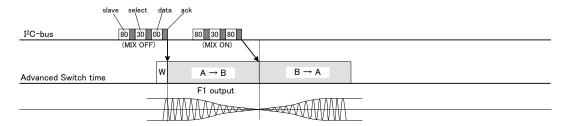


This is an example of in case of transmitted data of another status(MIX OFF) in during B→A transmission timing.

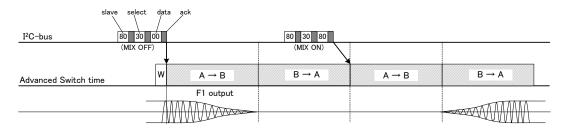


■ Transmission example 3
This is an example when transmission OFF to ON in short interval during to Mixing switching operation.

This is an example of in case of transmitted data of another status(MIX ON) in during A→B transmission timing.

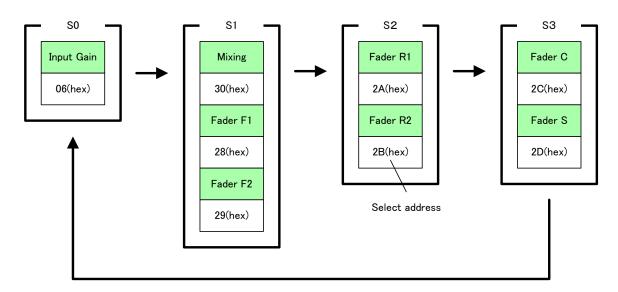


This is an example of in case of transmitted data of another status(MIX ON) in during B→A transmission timing.



2-3. About the data transmitting timing and the switching movement in several block state

When data are transmitted to several blocks, treatment in the BS (block state) unit is carried out inside the IC. The order of advanced switch movement start is decided in advance dependent on BS.



The order of advanced switch start

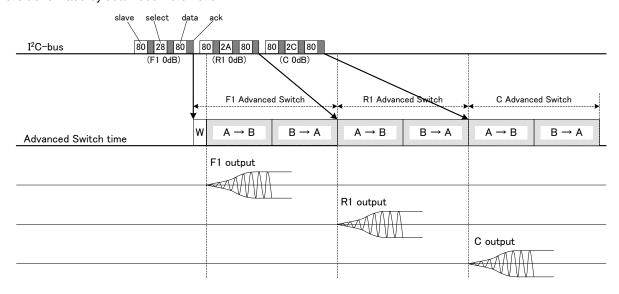
Note) It is possible that blocks in the same BS start switching at the same timing.

■ Transmitting example 1

About the transmission to several blocks also, as explained in the previous section, though there is no restriction of the I^2C - bus data transmitting timing, the start timing of switching follows the figure of previous page, The order of advanced switch start.

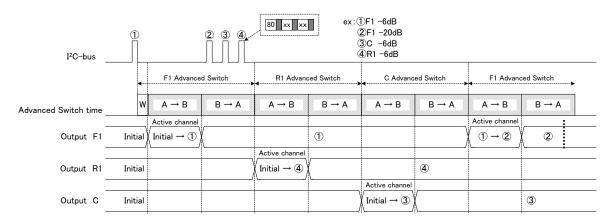
Therefore, it isn't based on the data transmitting order, and an actual switching order becomes as the figure of previous page, "The order of advanced switch start".

Each block data is being transmitted separately in the transmitting example 5, but it becomes the same result even if data are transmitted by automatic increment.



■ Transmitting example 2

In the case that data transmission order and actual switching order is different, or data is transmitted to the block in other BS before the advanced switch operation finished, switching of next BS starts after current switching.



Application Circuit Diagram

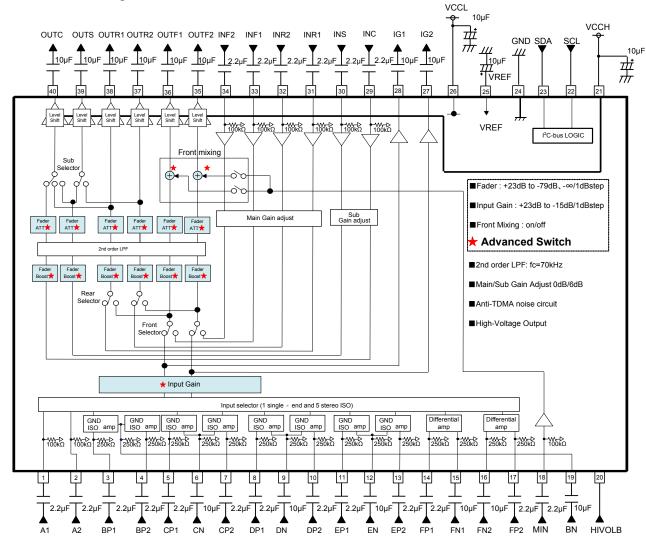


Figure 20. Application Circuit Diagram

Notes on wiring

- ①Please connect the decoupling capacitor of a power supply as close as possible to GND.
- ②Lines of GND shall be one-point connected.
- ③Wiring pattern of Digital shall be away from that of analog unit and cross-talk shall not be acceptable.
- (4) Lines of SCL and SDA of I²C-bus shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.
- ⑤Lines of analog input shall not be parallel if possible. The lines shall be shielded, if they are adjacent to each other.

Thermal Derating Curve

About the thermal design by the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy elements. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.

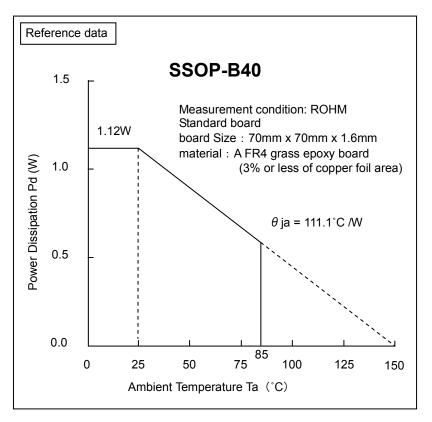


Figure 21. Temperature Derating Curve

Note) Values are actual measurements and are not guaranteed.

Note) Power dissipation values vary according to the board on which the IC is mounted.

I/O Equivalence Circuit

| | | ce Circuit | T | | |
|---|----------------------------------|-----------------------------------|---------------------|--------------------|--|
| - | Terminal No | Terminal Name | Terminal Voltage | Equivalent Circuit | Terminal Description |
| | 1 | A1 | 4.15V | VCCL | Terminal for signal input |
| | 2 | A2 | 7.10 | | |
| | 29 | INC | | ↓ | The input impedance is 100kΩ(Typ). |
| | 30 | INS | | . 191 | |
| | | | | | |
| | 31 | INR1 | | | |
| | 32 | INR2 | | T I | |
| | 33 | INF1 | | GND | |
| | 34 | INF2 | | O • | |
| | 18 | MIN | | | |
| | 3 | BP1 | 4.15V | | Input terminal |
| | 4 | BP2 | | | Single/Differential mode is selectable. |
| | 5 | CP1 | | | |
| | 6 | CN | | | The input impedance is 250kΩ(Typ). |
| | 7 | CP2 | | VCCL | |
| | 8 | DP1 | | | |
| | 9 | DN | | , | |
| | 10 | DP2 | | | |
| | 11 | EP1 | | | |
| | 12 | EN | | | |
| | 13 | EP2 | | T V | |
| | 14 | FP1 | | GND V | |
| | 15 | FN1 | | | |
| | 16 | FN2 | | | |
| | 17 | FP2 | | | |
| | 19 | BN | | | |
| | | | 4.45\/ | VÇCL | Input Gain output terminal |
| | 27 28 | IG2 IG1 | 4.15V | GND O | |
| | 35 36 37 38 39 40 | OUTF2 OUTF1 OUTR2 OUTR1 OUTS OUTC | 8.35/4.15V | VCCH GND GND | Fader output terminal High-Voltage OFF: 4.15V High-Voltage ON: 8.35V |

The figures in the pin explanation and input/output equivalent circuit is designed value, it doesn't guarantee the value.

| Terminal | Terminal | Terminal | Fauivalent Circuit | Torminal Description |
|----------|----------|----------|--------------------------|--|
| No | Name | Voltage | Equivalent Circuit | Terminal Description |
| 20 | HIVOLB | 5V | VCCL | Output gain control terminal Low(0V supply): High-Voltage ON High(terminal open): High-Voltage OFF |
| 21 | VCCH | 17/8.5V | | Power supply terminal |
| 26 | VCCL | 8.5V | | |
| 22 | SCL | _ | VCCL SV 1.65V | Terminal for clock input of I ² C-bus communication Note: When this pin is shorted to next pin(VCCH), it may result in property degradation and destruction of the device. |
| 23 | SDA | _ | VCCL O J 1.65V | Terminal for data input of I ² C- bus communication |
| 24 | GND | 0V | | Ground terminal |
| 25 | VREF | 4.15V | VCCL 12.5kΩ 4.15V GND | BIAS terminal Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in. |

The figures in the pin explanation and input/output equivalent circuit is designed value, it doesn't guarantee the value.

Application Information

1. Absolute maximum rating voltage

When voltage is impressed to VCCL/VCCH exceeding absolute-maximum-rating voltage, circuit current increase rapidly, and it may result in property degradation and destruction of a device.

When impressed by a VCCL terminal (26pin) especially by serge examination etc., even if it includes an of operation voltage +serge pulse component, be careful not to impress voltage (about 14V VCCL terminal) greatly more than absolute-maximum-rating voltage. And, be careful that there is no more than 18V VCCH terminal (21pin) also one.

2. About a signal input part

In the signal input terminal, the value of the input coupling capacitor C(F) should be sufficient—to match the value of input impedance $R_{IN}(\Omega)$ inside the IC. The first HPF characteristic of CR is as shown below.

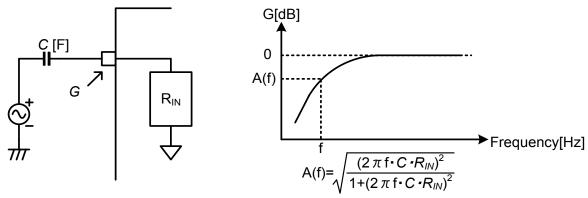


Figure 22. Input Equivalent Circuit

3. About output load characteristics

The usages of load for output are below (reference). Please use the load more than 10 k Ω (Typ).

Output terminal

| Terminal | Terminal | Terminal | Terminal | Terminal | Terminal | Terminal | Terminal |
|----------|----------|----------|----------|----------|----------|----------|----------|
| No. | Name | No. | Name | No. | Name | No. | Name |
| 28 | IG1 | 36 | OUTF1 | 38 | OUTR1 | 40 | OUTC |
| 27 | IG2 | 35 | OUTF2 | 37 | OUTR2 | 39 | OUTS |

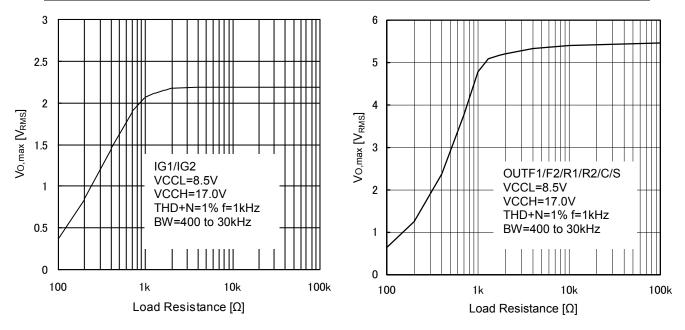


Figure 23. Output load characteristic at VCCL=8.5V, VCCH=17.0V(Reference)

Application Information - continued

4. About HIVOLB terminal(20pin) when power supply is off

Any voltage shall not be supplied to HIVOLB terminal (20pin) when power-supply is off. Please insert a resistor (about $2.2k\Omega$) to HIVOLB terminal in series, if voltage is supplied to HIVOLB terminal in case.

5. About signal input terminals

Because the inner impedance of the terminal becomes 100 k Ω or 250 k Ω when the signal input terminal makes a terminal open, the plunge noise from outside sometimes becomes a problem. When there is an unused signal input terminal, design so it is shorted to ground.

6. About changing gain of Input Gain and Fader Volume

In case of the boost of the input gain and fader volume when changing to the high gain which exceeds 20 dB especially, the switching pop noise sometimes becomes big.

In this case, we recommend changing every 1 dB step without changing a gain at once.

Also, the pop noise sometimes can reduce by making advanced switch time long, too.

7. About inter-pin short to VCCH

VCCH terminal(21pin) is assumed that applied high voltage(17.8 V_{MAX}) for realization of 5.2 V_{RMS} (MAX) output. And so, avoid short between VCCH and SCL, other. When Inter-pin shorts, circuit current increase rapidly, and it may result in property degradation and destruction of a device.

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the maximum junction temperature rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

Operational Notes - continued

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

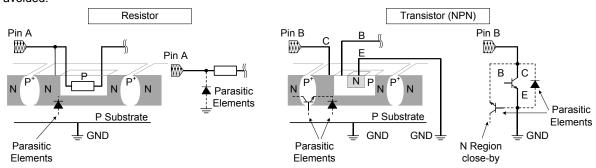
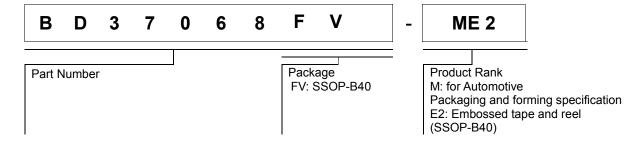


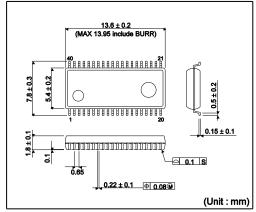
Figure 24. Example of monolithic IC structure

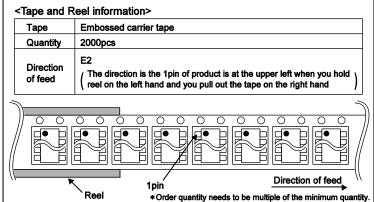
Ordering Name Selection



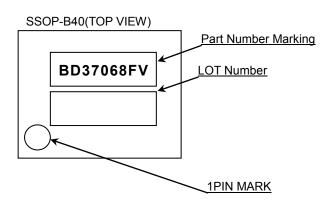
Physical Dimension Tape and Reel Information

SSOP-B40





Marking Diagram



Revision History

| Date | Revision | Changes |
|-------------|----------|---|
| 13.MAR.2014 | 001 | New Release |
| 14.NOV.2016 | 002 | Additional specification about advanced switch operation Additional specification of power supply sequence |
| | | Change document style of specification |

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|---------|--------|------------|----------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CLASSIII |
| CLASSIV | | CLASSⅢ | |

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